

200mW, 0.37V Schottky Barrier Diode

FEATURES

- Designed for mounting on small surface
- Low Capacitance
- Low forward voltage drop
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Adapters
- For switching power supply
- Low stored charge
- Inverter

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_{F(AV)}$	30	mA
V_{RRM}	40	V
I_{FSM}	0.2	A
V_F at $I_F=1mA$	0.37	V
T_J Max.	125	°C
Package	SOD-323	
Configuration	Single dice	

MECHANICAL DATA

- Case: SOD-323
- Molding compound meets UL 94 V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte Au plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: Indicated by cathode band
- Weight: 0.004grams (approximately)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	PART NUMBER	UNIT
Marking code on the device		5	
Repetitive peak reverse voltage	V_{RRM}	40	V
Forward current	$I_{F(AV)}$	30	mA
Non-repetitive peak forward surge current @ $t = 8.3ms$	I_{FSM}	0.2	A
Junction temperature range	T_J	-45 to +125	°C
Storage temperature range	T_{STG}	-45 to +125	°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-ambient thermal resistance ⁽¹⁾	$R_{\theta JA}$	500	°C/W

Notes:

1. Valid provided that terminals are kept at ambient temperature

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 1\text{mA}$, $T_J = 25^\circ\text{C}$	V_F	--	0.37	V
Reverse current @ rated V_R per diode ⁽²⁾	$V_R = 30\text{V}$ $T_J = 25^\circ\text{C}$	I_R	--	0.5	μA
Junction capacitance	1 MHz, $V_R = 0\text{V}$	C_J	2		pF

Notes:

1. Pulse test with $PW = 0.3\text{ ms}$
2. Pulse test with $PW = 30\text{ ms}$

ORDERING INFORMATION

PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
RB751V-40 (Note 1)	RR	G	SOD-323	3K / 7" Reel

Notes:

1. Whole series with green compound

EXAMPLE

EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
RB751V-40 RRG	RB751V-40	RR	G	Green compound

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Typical Forward Characteristics

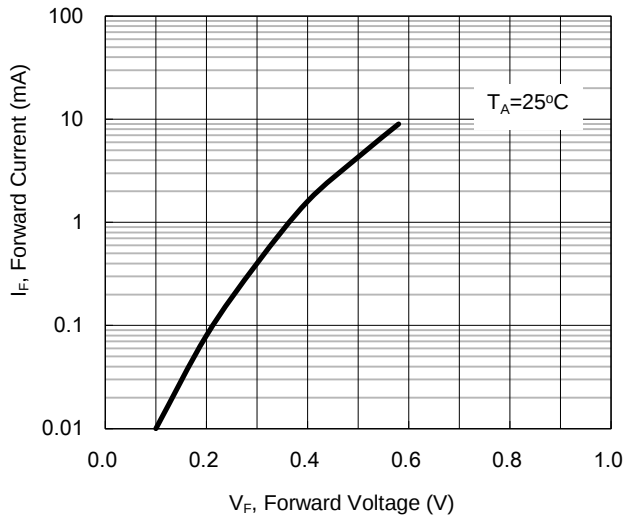


Fig.2 Forward Current Derating Curve

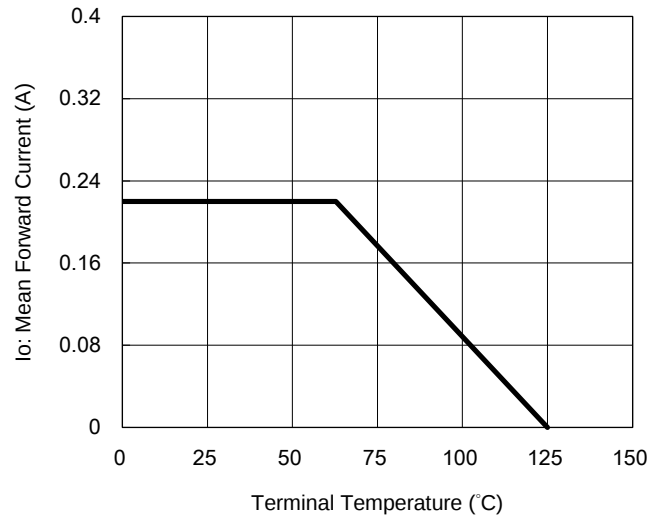


Fig.3 Admissible Power Dissipation Curve

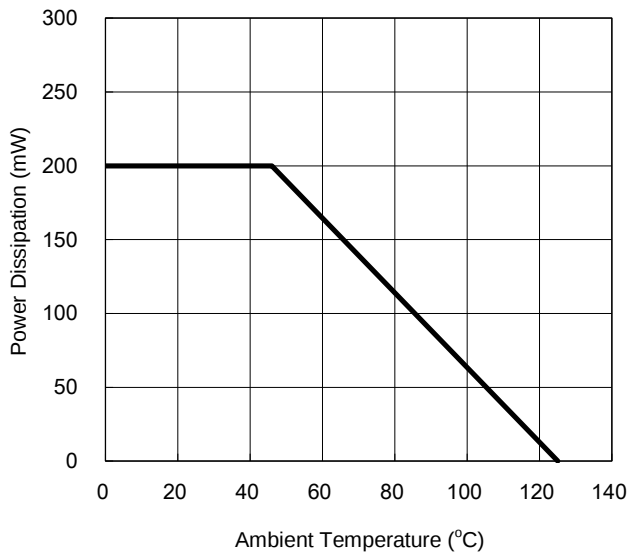
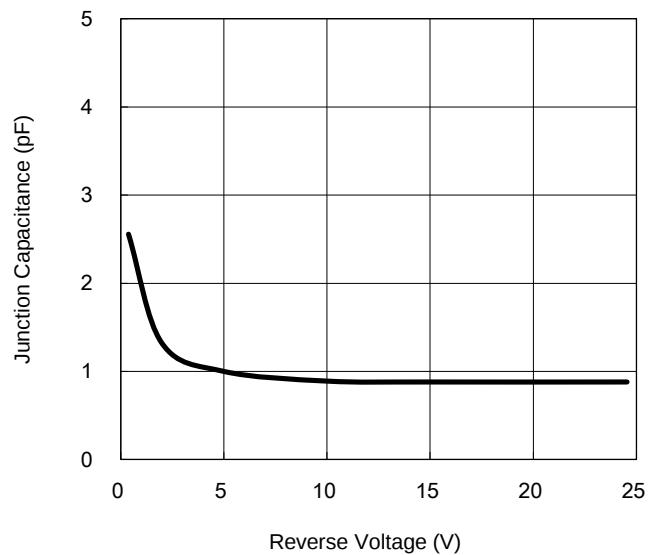
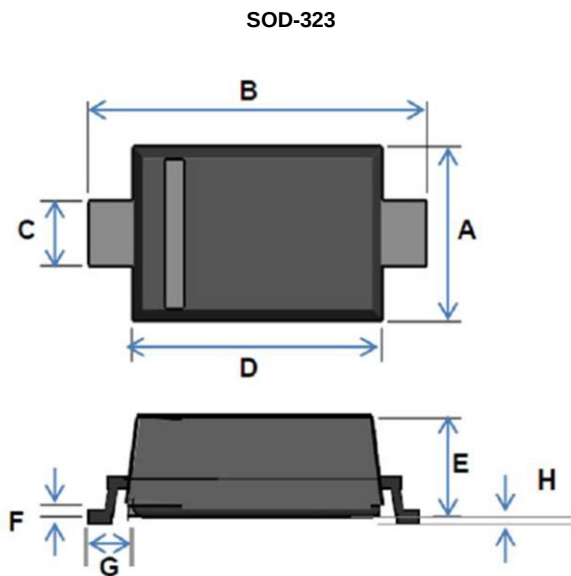


Fig.4 Typical Junction Capacitance

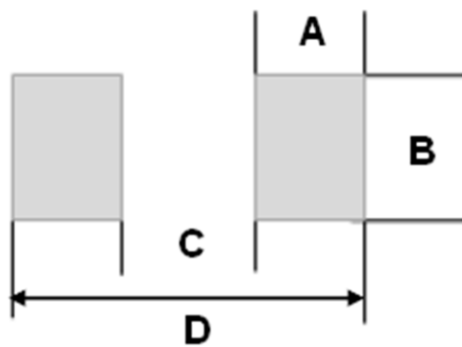


PACKAGE OUTLINE DIMENSION



DIM.	Unit(mm)		Unit(inch)	
	Min	Max	Min	Max
A	1.150	1.400	0.045	0.055
B	2.300	2.700	0.091	0.106
C	0.250	0.450	0.010	0.018
D	1.600	1.800	0.063	0.071
E	0.800	1.000	0.031	0.039
F	0.050	0.177	0.002	0.007
G	0.475 REF		0.019 REF	
H	--	0.100	--	0.004

SUGGEST PAD LAYOUT



DIM.	Unit(mm)	Unit(inch)
	Typ.	Typ.
A	0.63	0.025
B	0.83	0.033
C	1.60	0.063
D	2.86	0.113

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